X-band Design + R&D Report

For teams from SLAC, KEK, LBNL, LLNL, BINP, IHEP...
ICFA Seminar '99 FNAL

Nobu Toge (KEK, Accelerator Lab) In this talk I will present the status of R&D efforts towards linear collider designs that are based on the X-band RF technology for the main linacs.

This work is pursued mainly by SLAC (US) and KEK (Japan) with a number of collaborating institutes around the world (LBNL, LLNL, BINP, IHEP, (1) ---

Partnership in the form of "International Study Group" (ISG) exists between SLAC and KEK, and the majority of the work presented here has been done in this context, if not all.

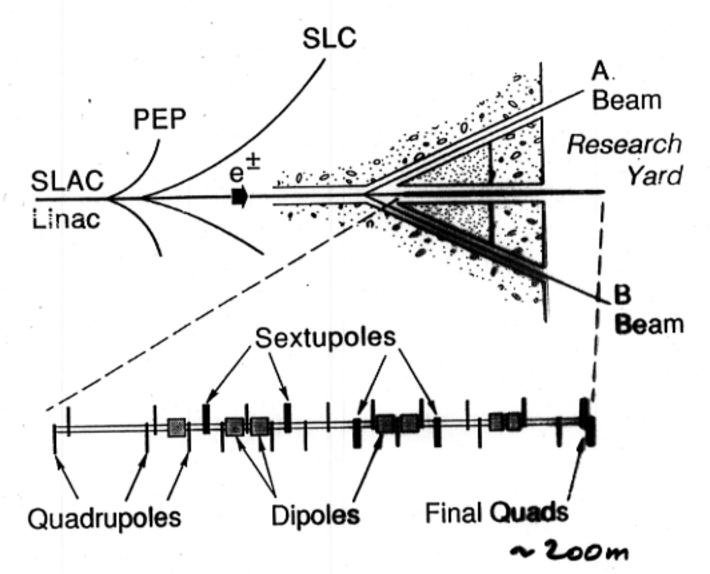
I will visit the topics as follows:

- SLAC-KEK ISG, Background
- Introduction to the X-band Linac Design
- Technology development status
 Klystron modulators
 Klystrons
 Power Distribution System
 Accelerating Structure
- Prospects and conclusions

SLAC-KEK ISG and its Background

- Long-standing history of cooperation (since '80s)
- LC concepts with similar technology basis.
- MoU between the lab directors in early 1998 for: Joint efforts of certain pre-(conceptual) design work.
 - Common design parameters.
 - Common or mutually-compatible hardware schemes.
 - Information sharing within the US-Japan HEP collab protocol.
 - Periodic general meetings (twice a year)
 - Prepare status report by early 2000.
- Many labs and Univs involved besides KEK and SLAC.
- Long-term future of ISG is pending negotiations between the KEK and SLAC lab directors, based on -
 - ISG status report
 - Community discussions





8-90

Final Focus Test Beam

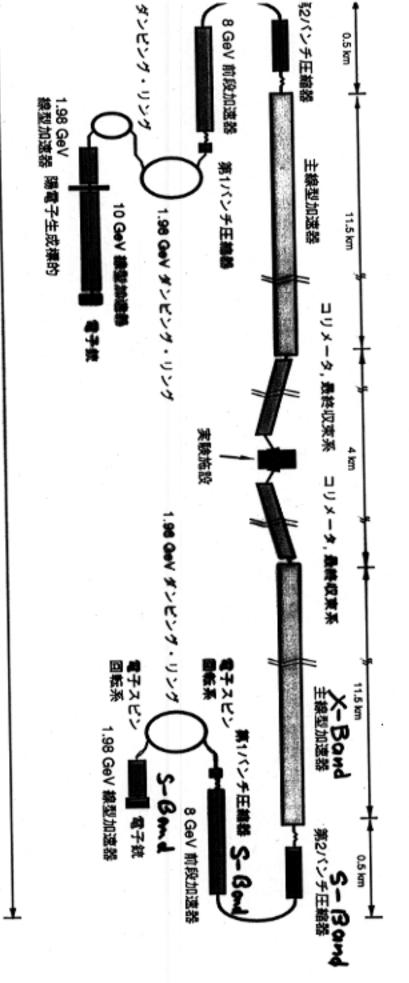
6700A2

$$\gamma \in y \sim 2 \times 10^{-6} \text{ m} \text{ in FFTB}$$
 $\gamma \in y \sim 2 \times 10^{-6} \text{ m} \text{ in FFTB}$
 $\gamma \in y \sim 6.5 \times 10^{9}$
 $\sigma \in /\varepsilon = 0.05 \sim 0.1\%$

if $\beta * = 0.13 \text{ mm} = \sigma = \sigma = 52 \text{ nm}$

電子・陽電子リニア・コライダー JLG

重心系エネルギー:E_{CM} = 500 GeV JLC-I → E_{CM} ≥ 1 TeV JLC-II



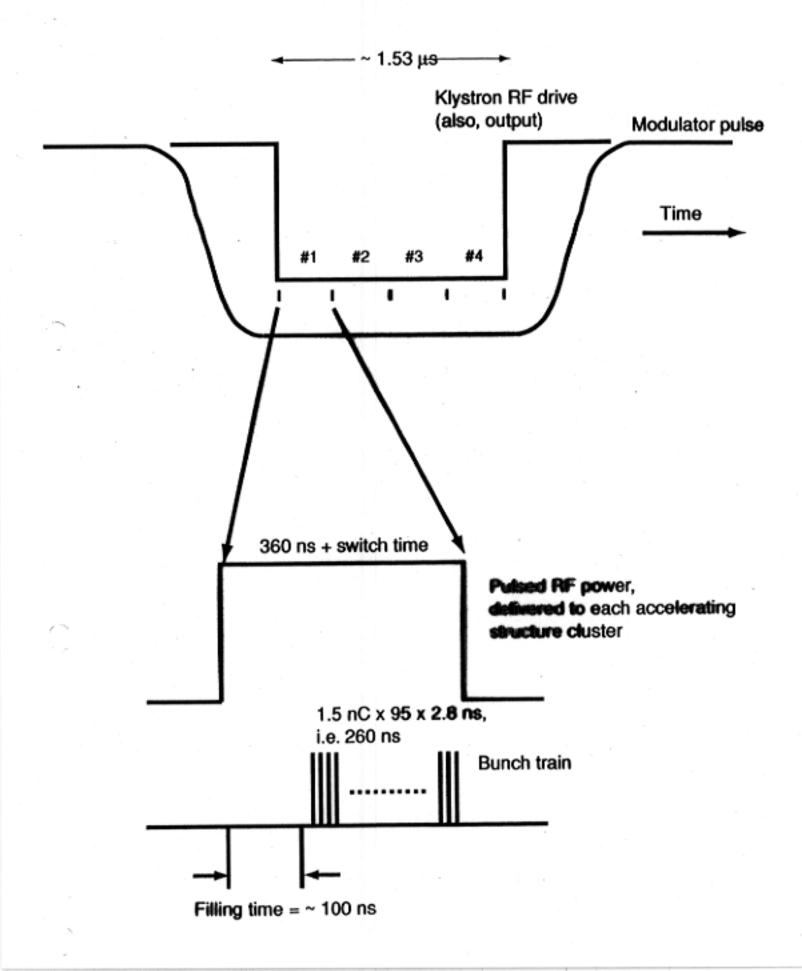
- 28 km

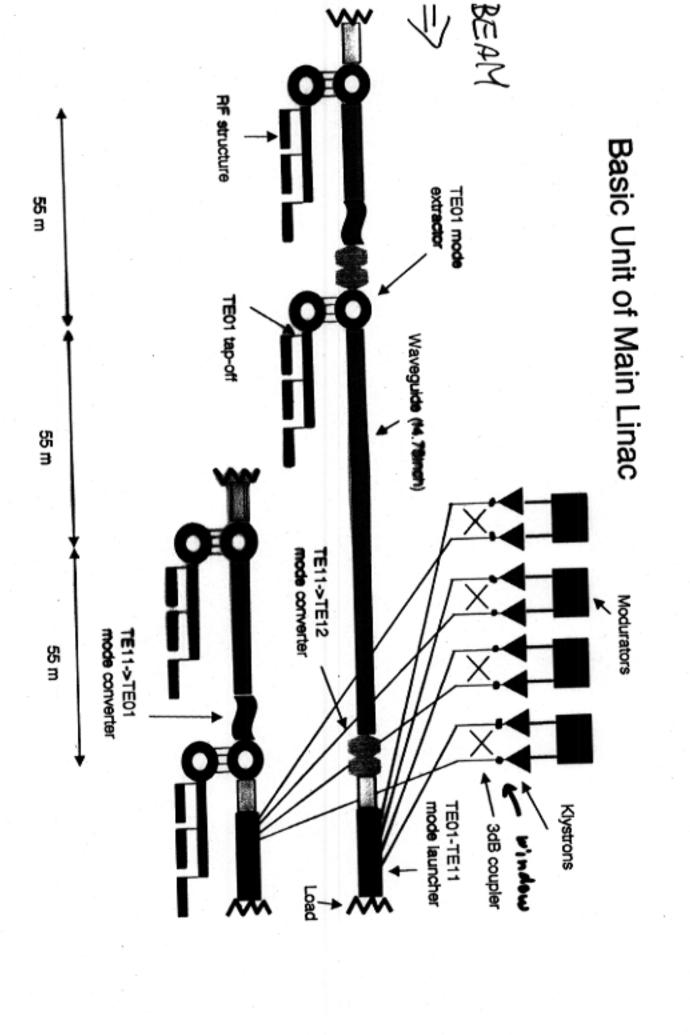
X-band Linac Design

11.424 GHZ

- Considerations on the design parameters have been already covered in Tor Raubenheimer's talk (NLC and JLC share common basic parameters)
- 500 GeV --> 1 TeV adiabatic upgrade with the same RF system: 55 MV/m loaded acc. gradient, which is realized by:
 - Conventional or solid-state-switch based modulator.
 - 75 MW, 1.53 µs X-band klystron with permanentmagnet focusing.
 - Highly efficient power distribution with DLDS (delayline distribution system) concept.
 - Damped-Detuned Structure with Rounded corners (RDDS), 1.8 m-long each for accelerating trains of bunches (95 x 1.1E10 elec/bunch, 2.8 ns apart)
 - We are yet to demonstrate beam acceleration with ultimate emittance preservation in a full-fledged, complete RF system above; but we have made good progress in recent component R&D.
 - Also, we have operated small / medium-scale systems at NLCTA (SLAC) and ATF Linac (KEK) for demonstrating certain aspects of technology that are needed at X-band linacs.

Relationship between the RF Power and Bunch Train





LINAC SECTOR - DLDS NONET

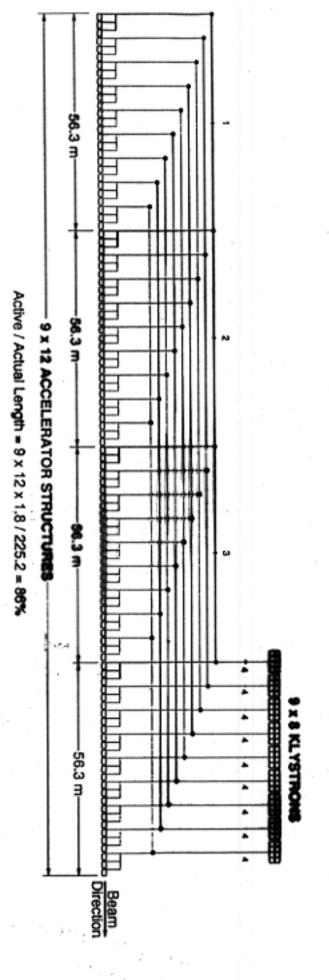


Table of Paremters for the X-band Main Linacs

	Phase-1	Phase-2
Final Energy / linac Particles / bunch Bunch Spacing Bunches / pulse Pulse repetition rate Effective gradient Klystron Power	2. 9 120 (- 5	500 GeV .1 E10 8 ns 5 - 150?) Hz 5 MV/m 75 MW
Klystrons / linac Structures / linac	1600 2400	3200 4800

- Decisions made in 1997 1998 thru SLAC-KEK discussions:
- Same RF system through Phase-1 and 2.
- Increased bunch spacing to 2.8 ns (was 1.4 ns)
 Beam-loading reduction: 28% --> 16 %
 Reduction of unloaded gradient: 85 --> 74 MV/m
- Increased klystron pulse width (was 0.96 μs)
- Adoption of DLDS scheme
 ... leading to reduction of #klystron by 1/3.
- Adoption of RDDS cell design

 leading to increased RF -> Beam efficienty
 (up 6%)

Technology Development – Klystron Modulators

■ What do we need?

500 kV, 530 A, 2.0µs output 1.5 µs flat-top width Energy efficienty goal: 75 %

Where are we? "2- pack" implementation

Proven conventional technology exists, in principle.

Issues exist in -

Reduction of cost for fabrication and maintenance.

modular wastruck to take assy
What are we doing?

Operation and construction of conventional thyratron-PFN modulators with attention to a lot of details. Stray induction to a lot of details. Removal of thyratrons and/or PFN by using:

IGBT switches --> induction modulator or SI-thrystor stackswitch or...

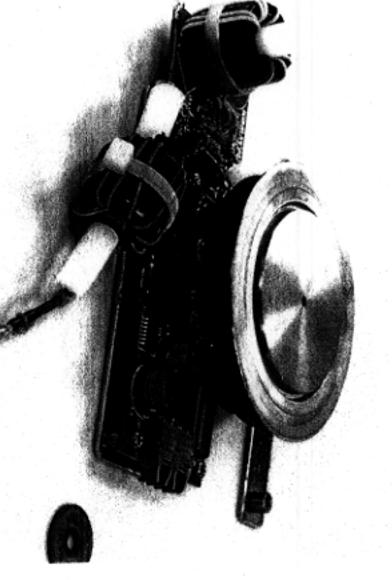
(It will take some time and resources)

Thyratron Charging Supply Pulse Forming Network 1:14 Transformer

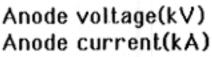
KEK-NOK Si-thyristor switch

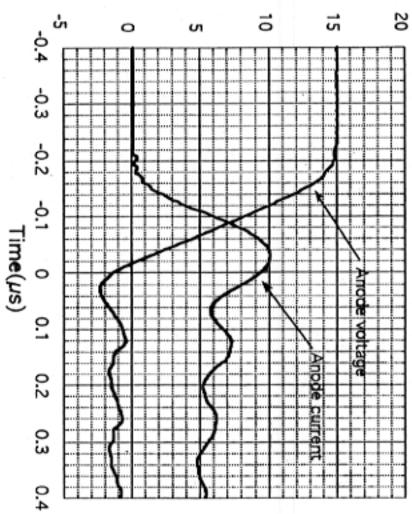
di/dt ~ 110 kA/ms

1 UNIT : SKV 10KA



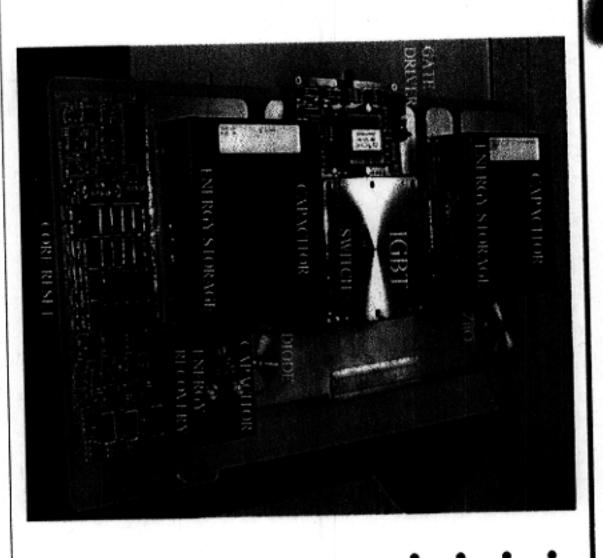






Test results from 5-stack

Drive PC Board



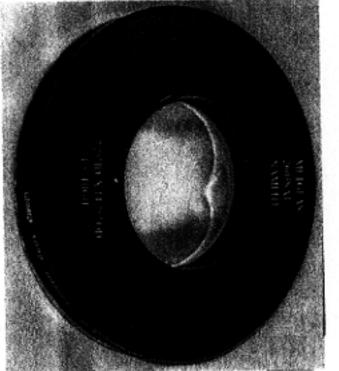
- 2.5 kV pulse
- 2 kA 3uSec.
- 25 ufd 5kV Cap

120 A core reset

Modulator Core & Case

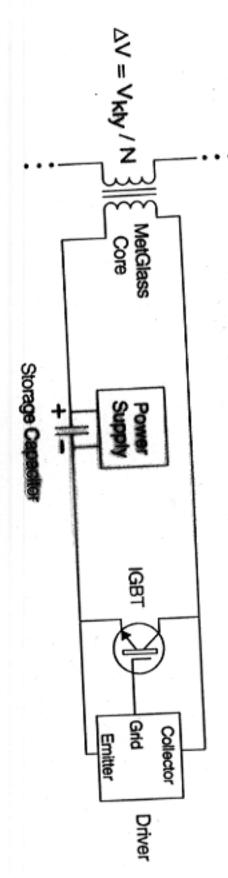


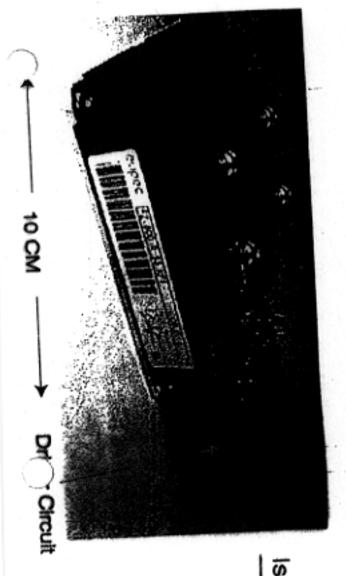
- 6.5" ID double ended drive core
- 0.006 Volt-Sec core
- 4kV 1.5uSec 0.5 Joules loss



SUM MANY LOW VOLTAGE SOURCES INDUCTIVELY 11YUUU 1 1014 1410 UUUU ...

INDUCTION CIRCUIT (1 OF N)





Isolated Gate Bipolar Transistor

Rated: 3.3 kV @ 0.8 kA (DC)

Tested: 2.0 kV @ 1.5 kA (Pulsed)

Future: 5.0 kV @ 2.0 kA (Pulsed)

Technology Development – Klystrons

What do we need?

75 MW peak power 1.53 µs output pulse 120 (-150) Hz rep. rate

For Ecm = 500 CreV

High efficiency, reliable, low-manufacturing cost, low-maintenance cost, low-operation cost...

-> High M. PPIM tubes

Where are we?

We have clearly met the R&D goal a few times.

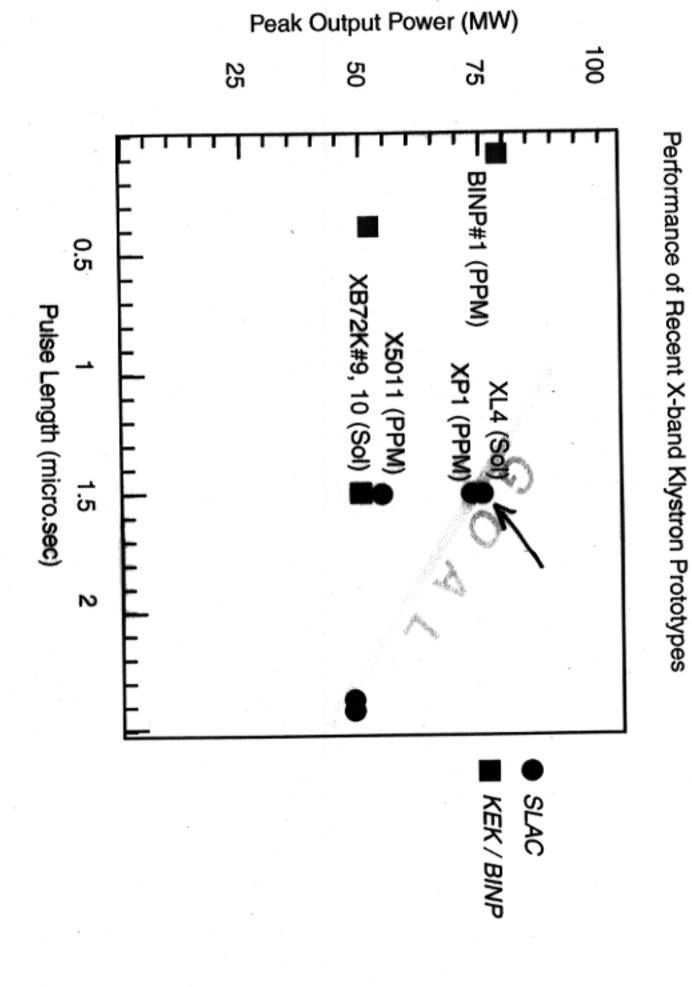
Very good simulation codes at hand. Pretty good understanding if the subject is a 2-dim problem. 3-dim code exists and in use, too, although very CPU intensive work.

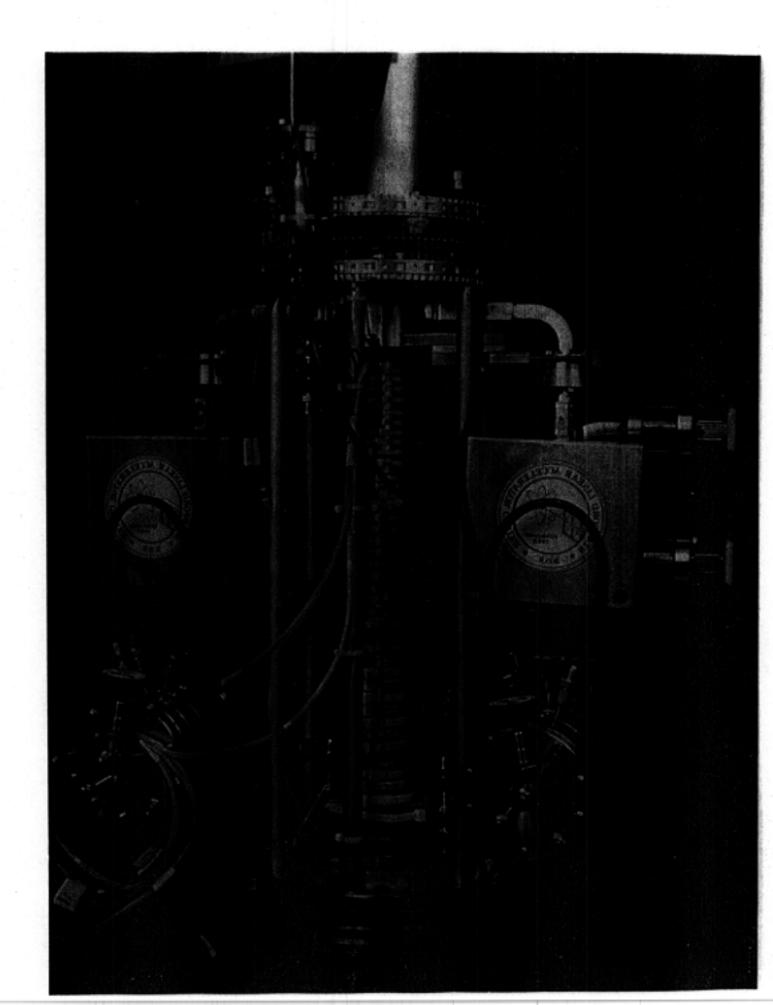
Reliability of XL4 (SLAC, solenoid-focusing) model has been excellent. Need to do the same with PPM tubes.

However, in general, technology of PPM (permanentmagnet focusing) klystron still has to be established.

What are we doing?

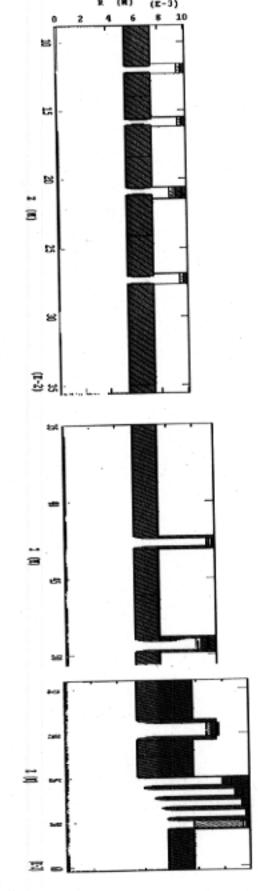
Testing and design of XP1, XP3 (SLAC) models, KEK-BINP #2, KEK PPM#1 models. Approx. 1 - 2 tubes/year at each lab.



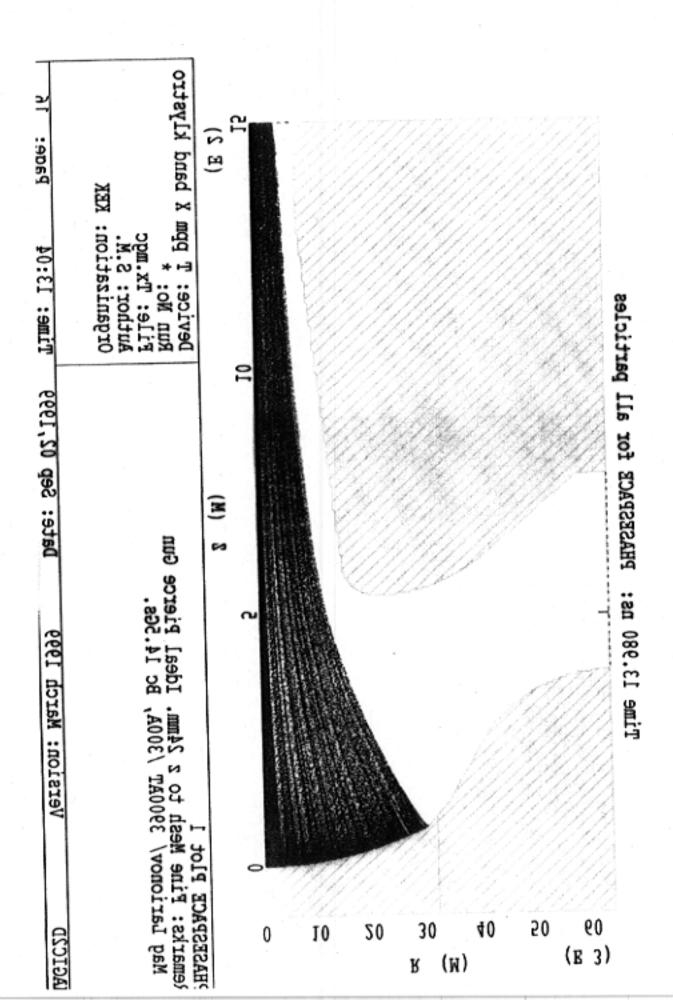


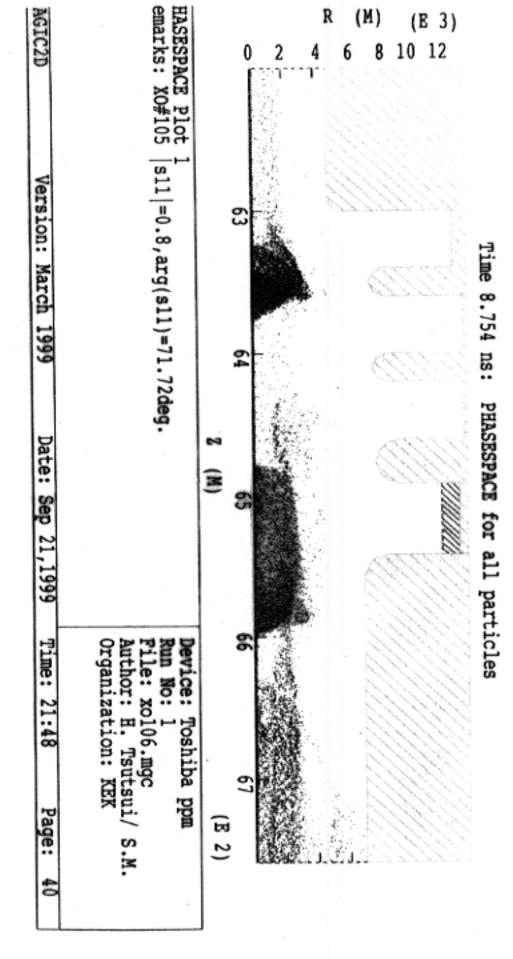


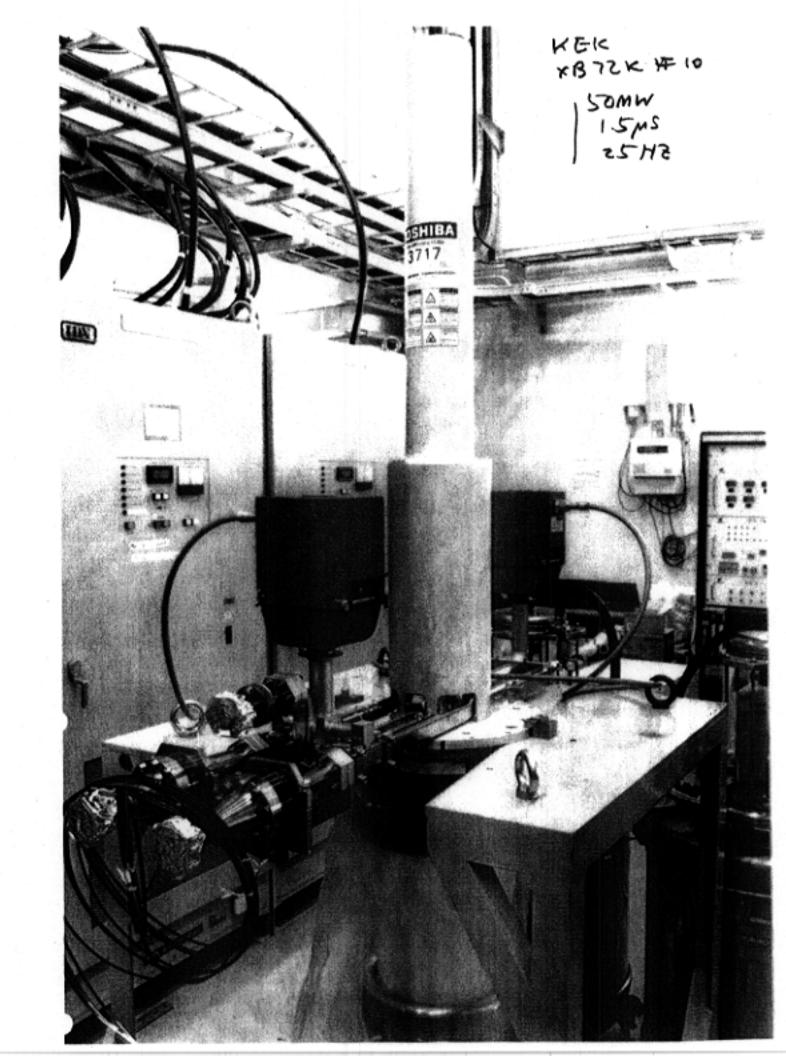
MAGIC Results



Beam voltage=490KV, Beam current=275A
Drive power=300Watts,
Output power=84MW, Efficiency=62.7%







Technology Development – RF Power Distribution

■ What do we need?

200 DLDS Ensembles

per Linae @ Ecm = 500

Gev

Design and demonstrate DLDS (Delay-Line Distribution System).

Several design variants are possible. The first task was to see if we can/should continue pursuing what we-call 2x2 DLDS. Three issues need to be looked at.

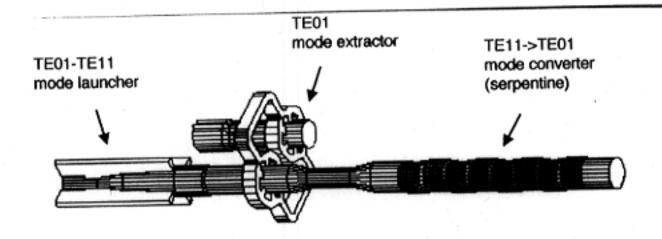
- Feasibility of RF switching components.
- Transport of X-band RF through delay lines.
- Check-out of the two subjects above in low-power and high-power RF testing
- Where are we?

Low-power testing of RF switching components showed satisfactory results.

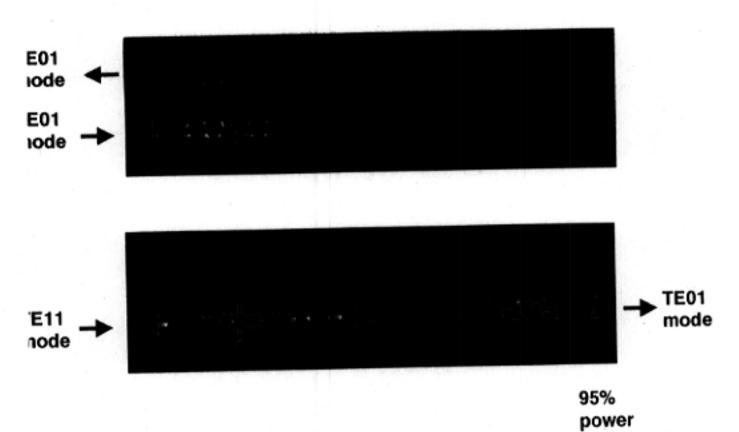
Low-power testing of X-band RF transport (TE12mode over 55 m) showed no traces of mode degredation / mixing / rotation.

So we intend to move on to high-power RF component design and testing in yr 2000.

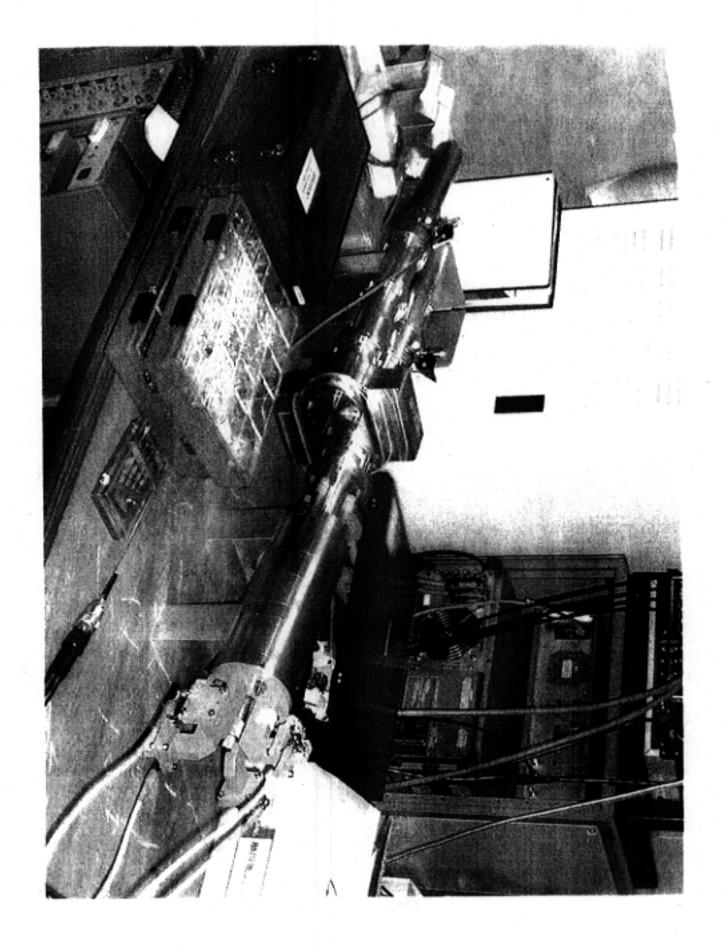
- 30 dB admixture 21° TE12 rotation



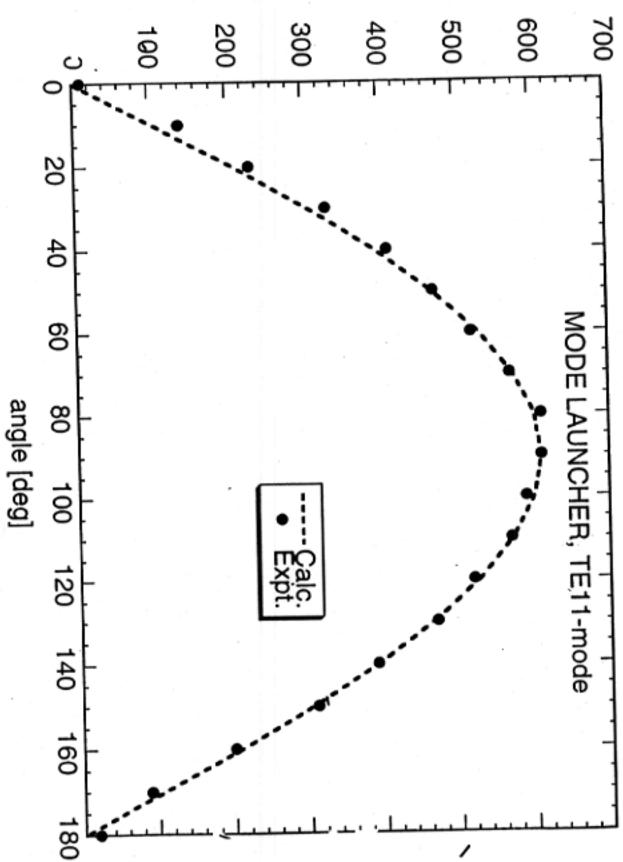
96% power transmission



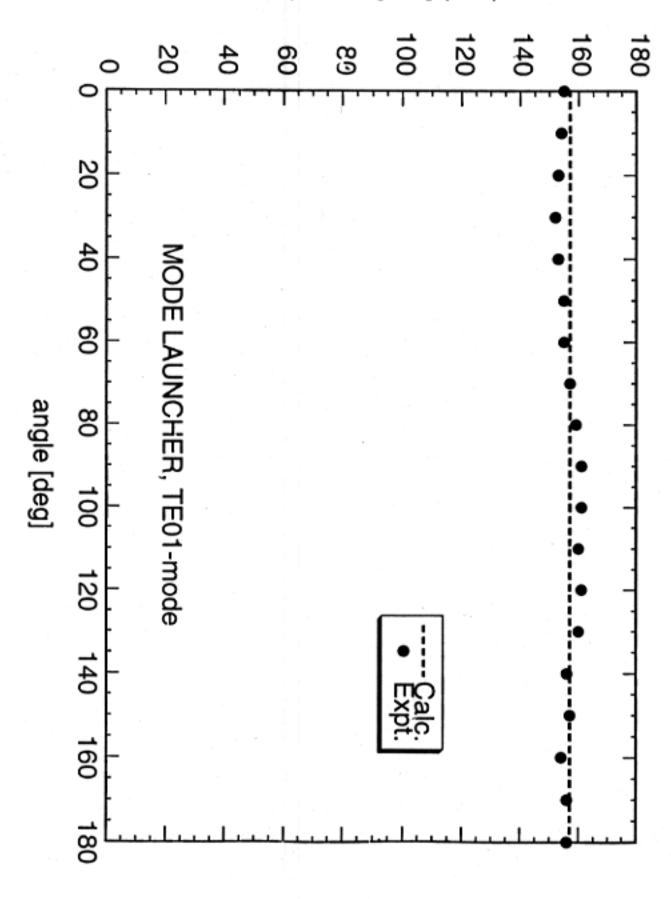
transmission

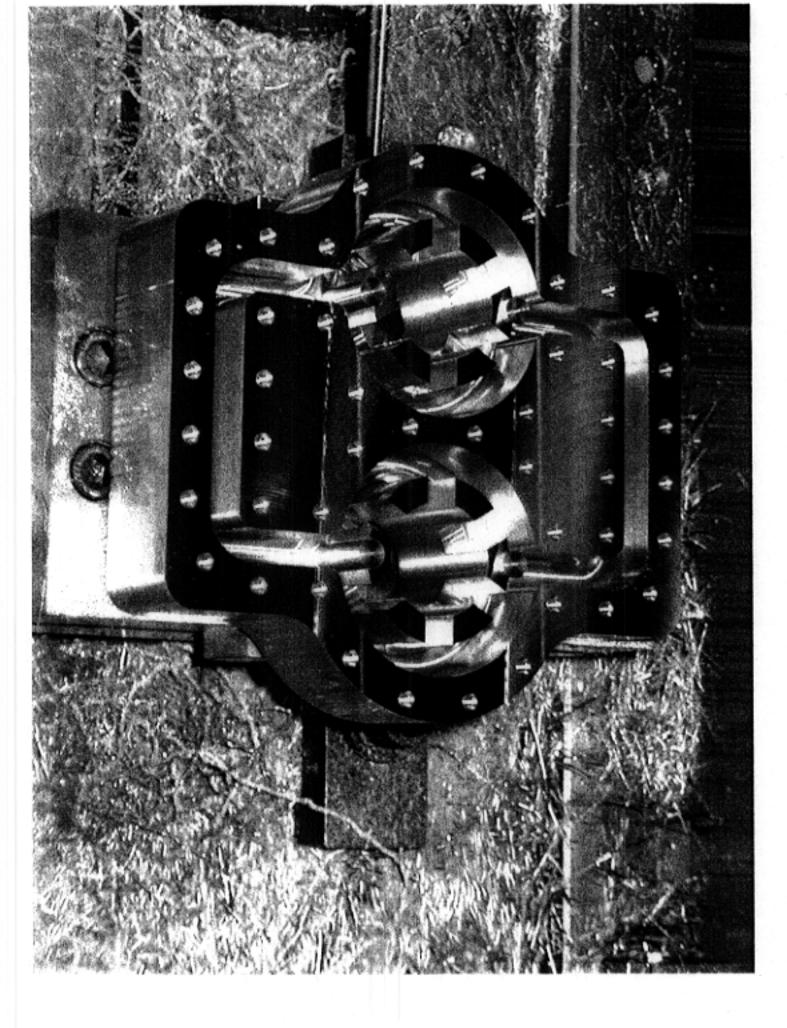


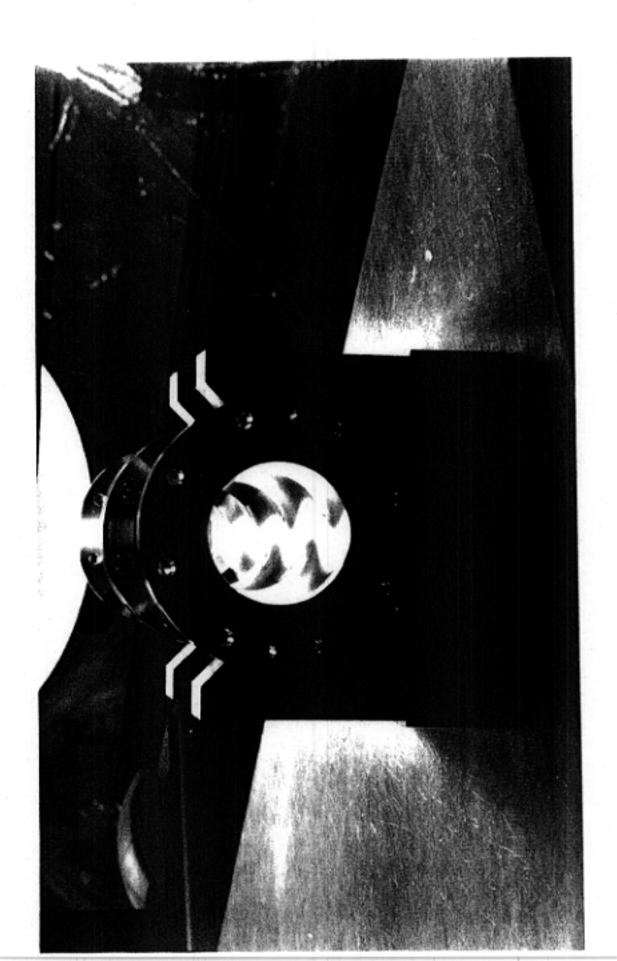
Amplitude [mU] (x100)

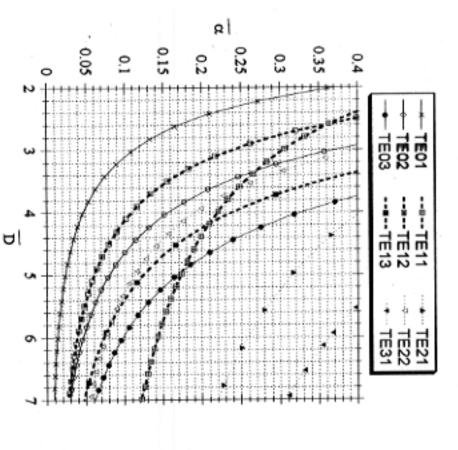


Amplitude [mU] (x10)



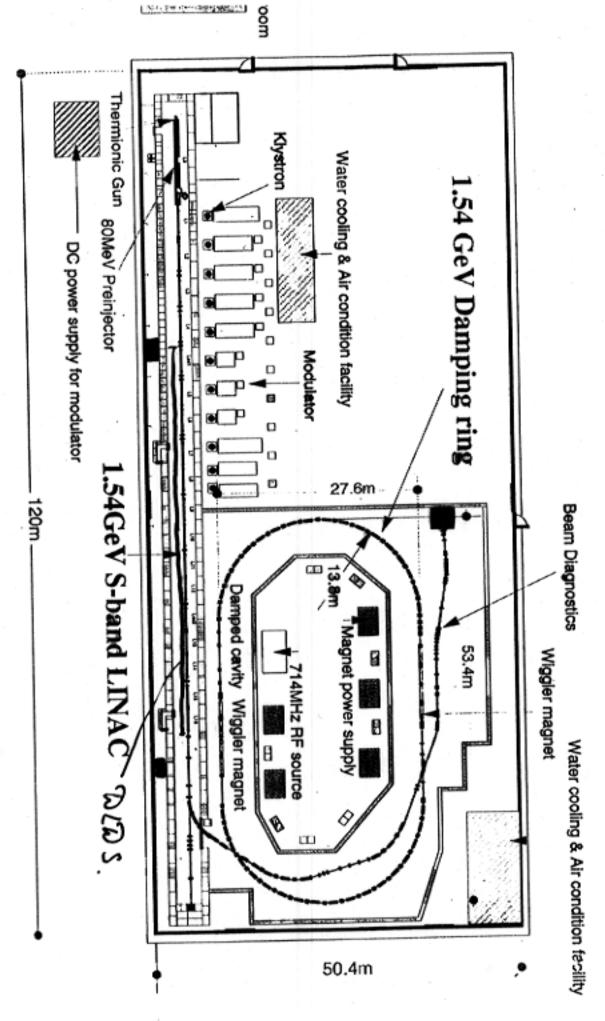


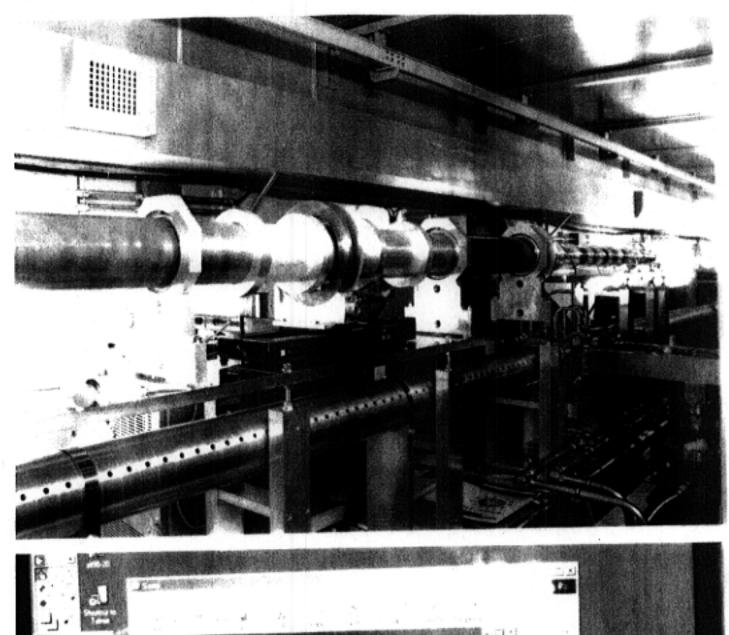


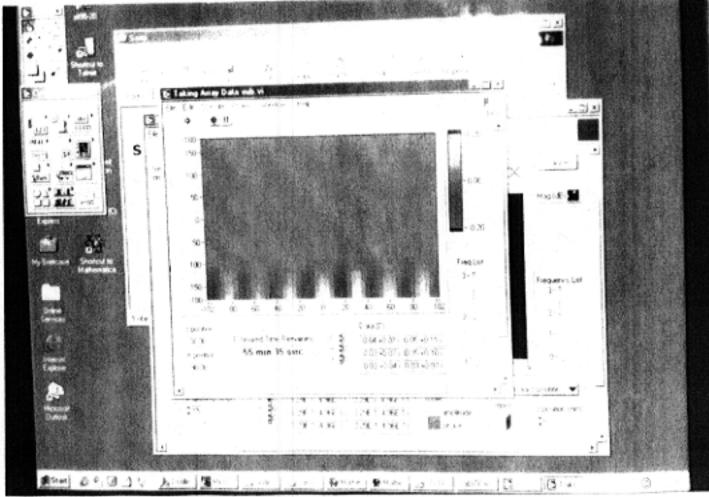


Relative attenuation of different modes per unit time in circular waveguide versus the normalized diameter of the waveguide.

Accelerator Test Facility for JLC







Technology Development – Accelerating Structure

What do we need? $a/\lambda = 0.18$ $2/3-\pi$ mode, damped-detuned structure with rounded corners. 1.8m-long., which can take 70MV/m if not loaded with beam.

Reduction of wakefield in the multi-bunch environment has to give

Wake amplitude < 1 V / pC / m / mm

Which means,
Disk fabrication tolerance < O(μm)
Disk assembly tolerance < O(a few ~ 10 μm)
for smoothness
Structure alignment tolerance < O(a few 10μm)

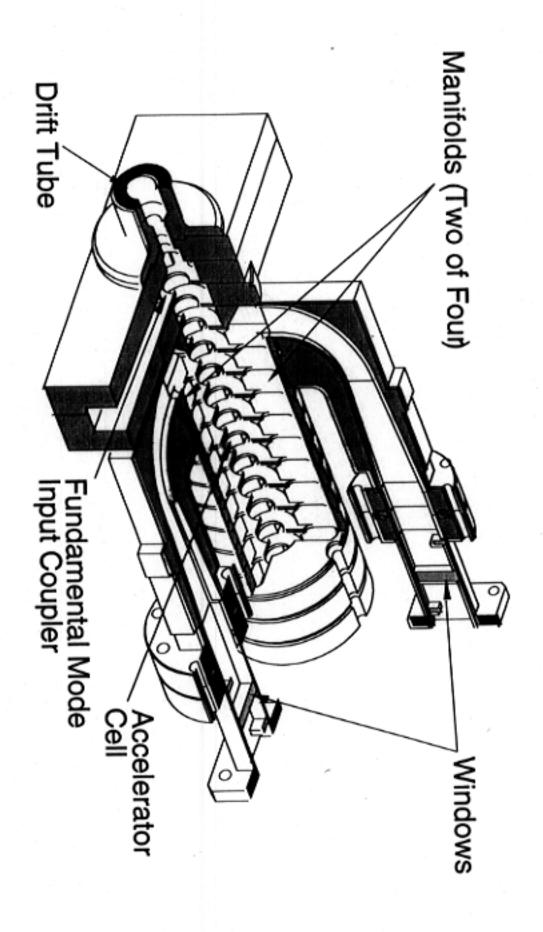
■ Where are we?

Experiences of several successful structure prototypes in the past. Without rounded-corners, we saw good calc-exp agreement on wake damping, HOM signal at ASSET experiments (SLAC).

RF processing of a prototype structure (1.3m-long) up to 85MV/m has been successful, though we need more studies.

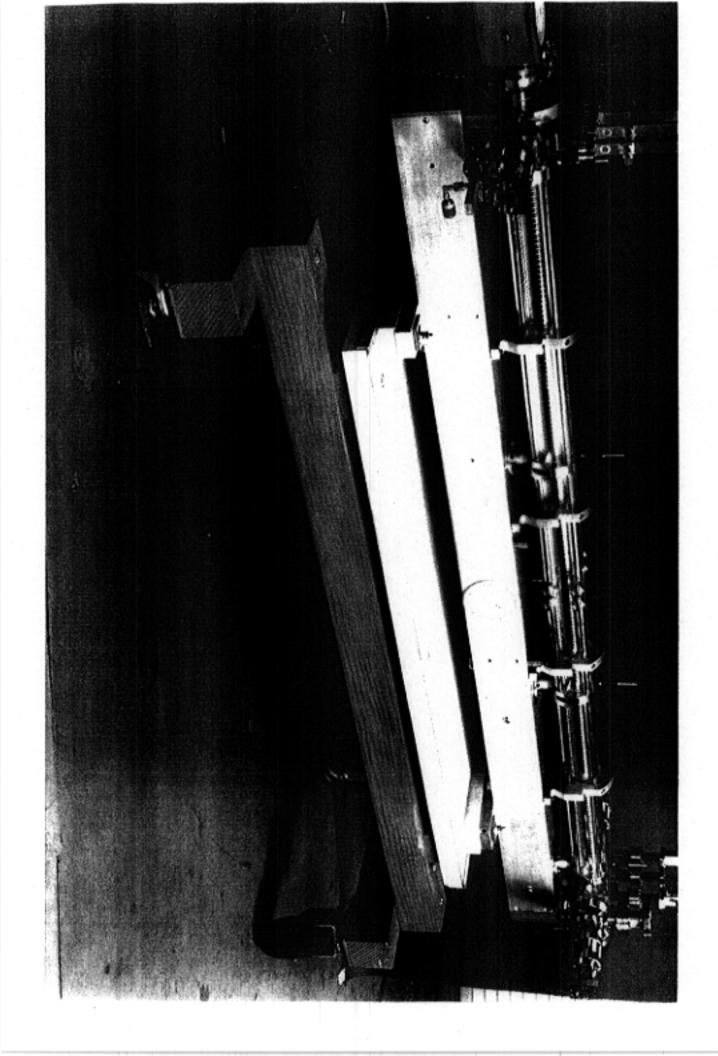
Electrical design of first RDDS prototype well at hand.

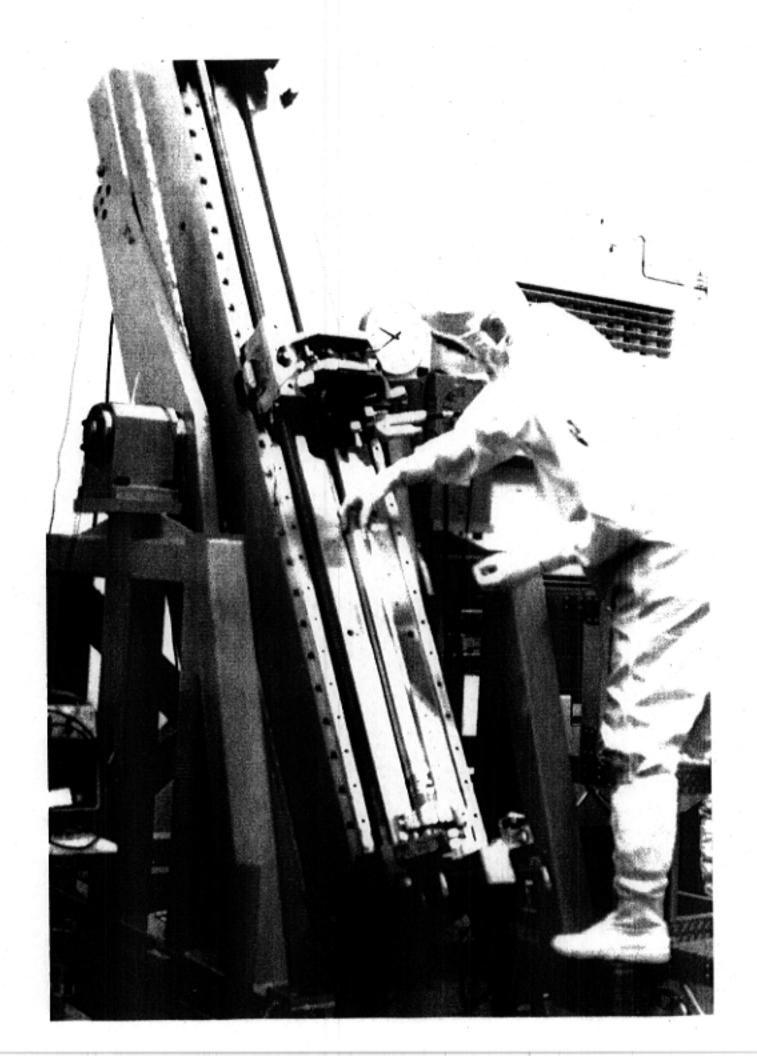
Fab and assembly technologies for DDS/RDDS are in good control at lab level, while their industrialization is a big subject yet to be fully established.

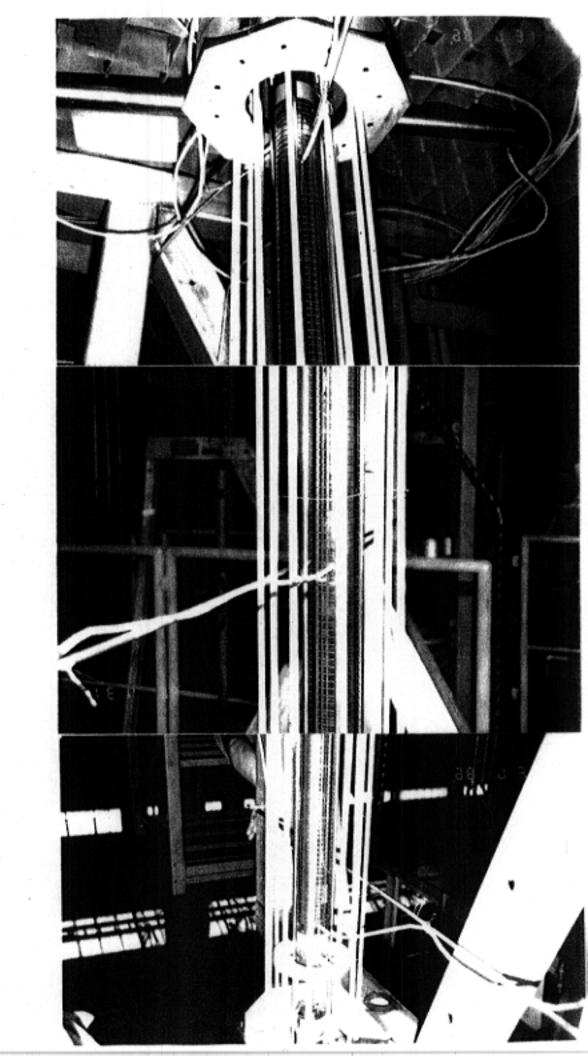


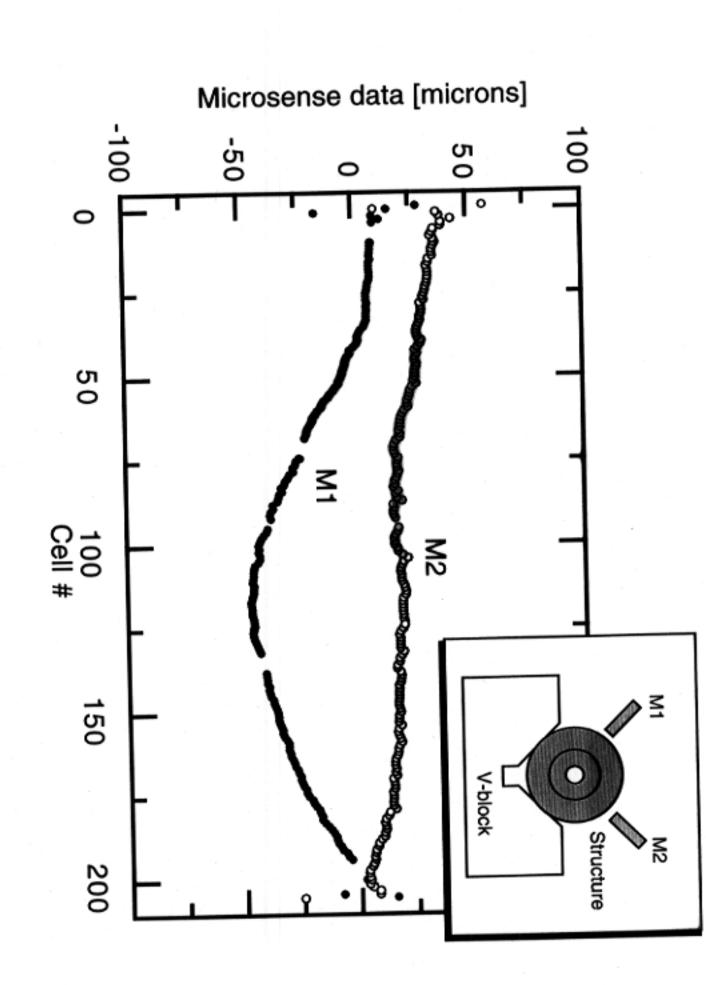
Cutaway view of the upstream end of DDS3.



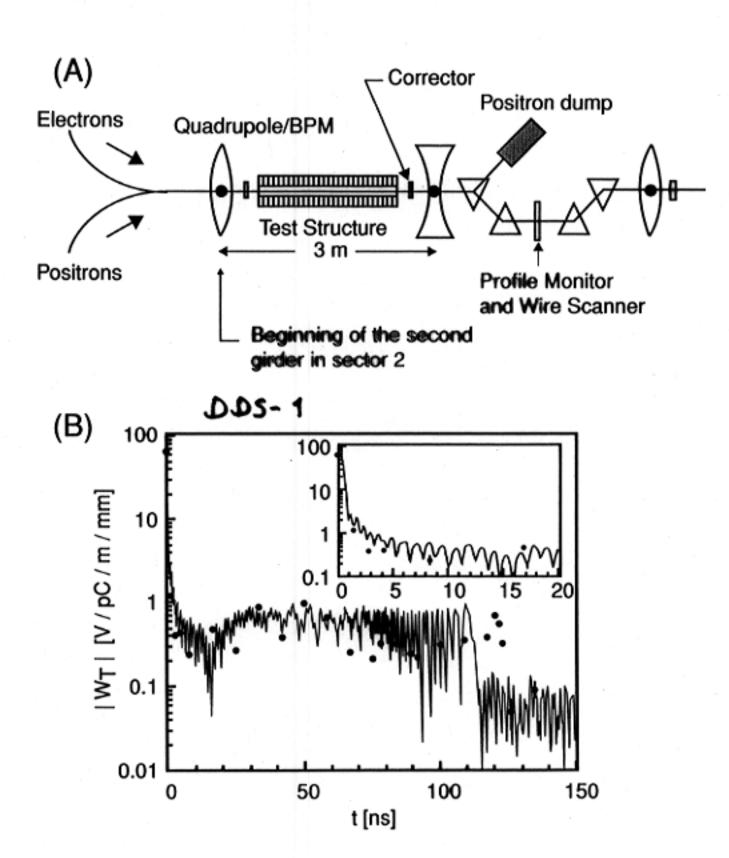




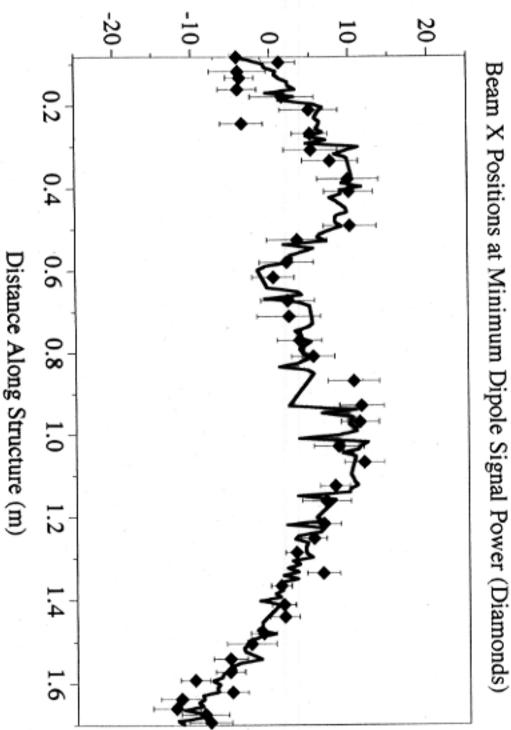




ASSET (SLAC)



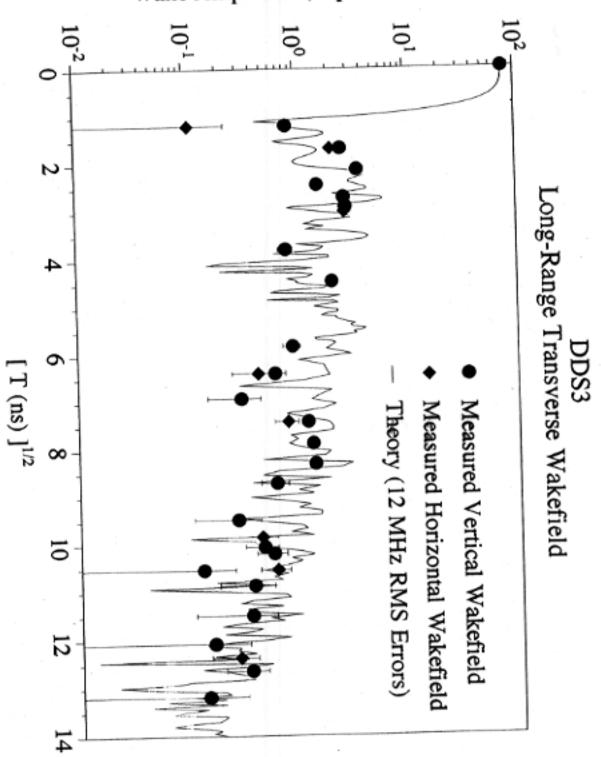
Cell Offset meas. by CMM and Beam Position at Min. Power (µm)

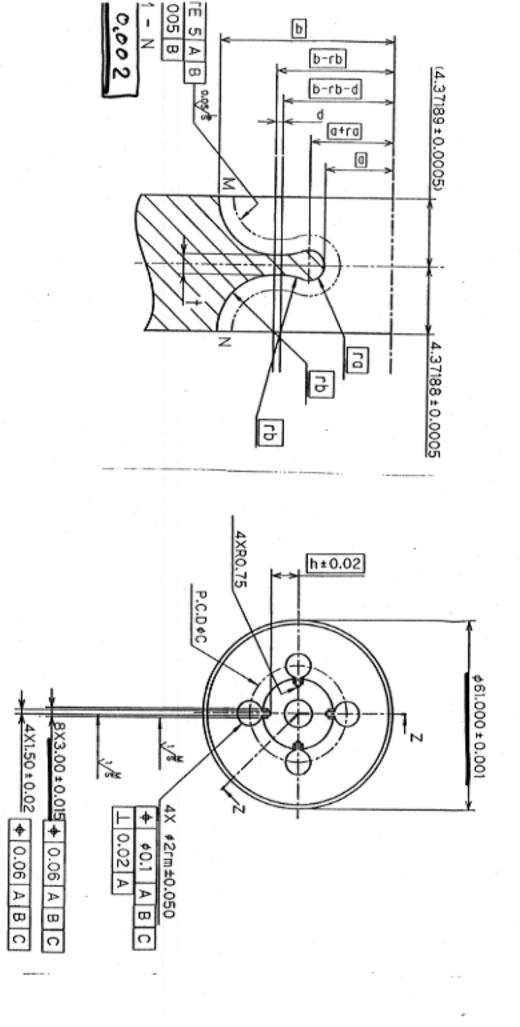


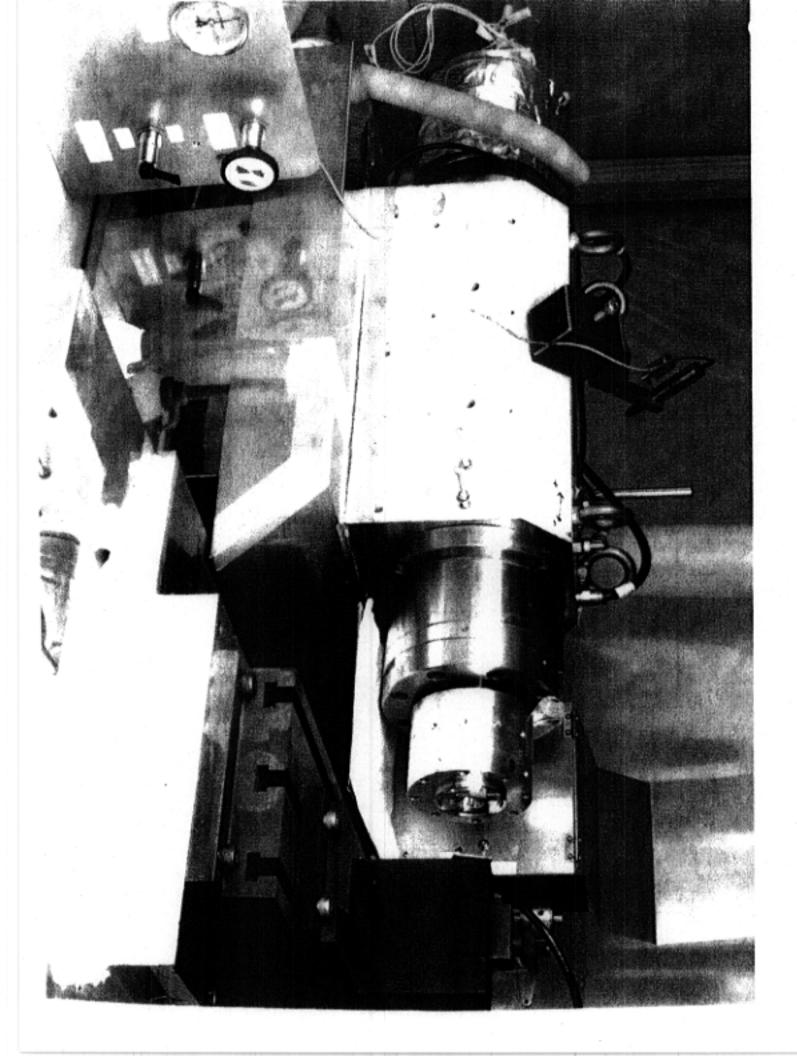
DDS3 Structure Straightness

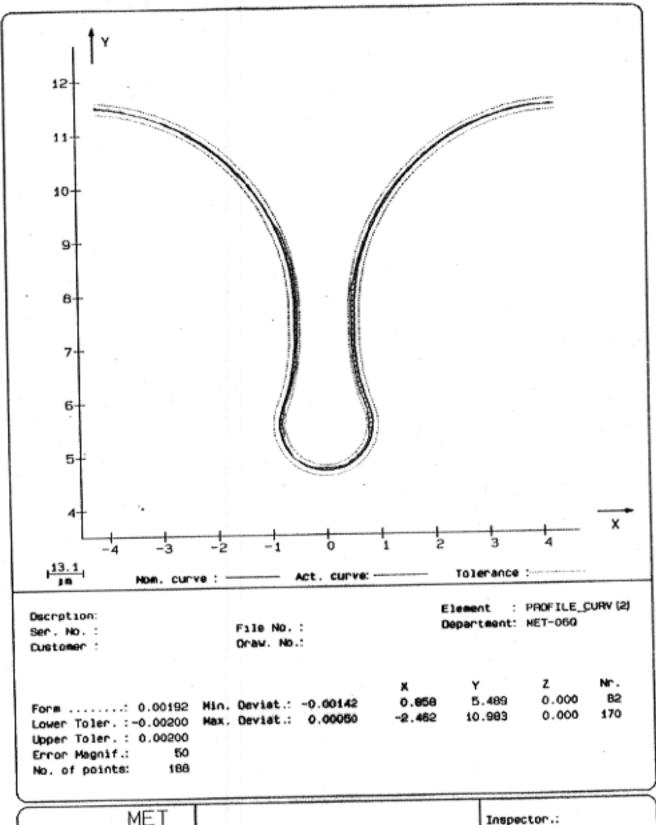
Horizontal CMM Data (Solid Line) and

Wake Amplitude (V/pC/m/mm)









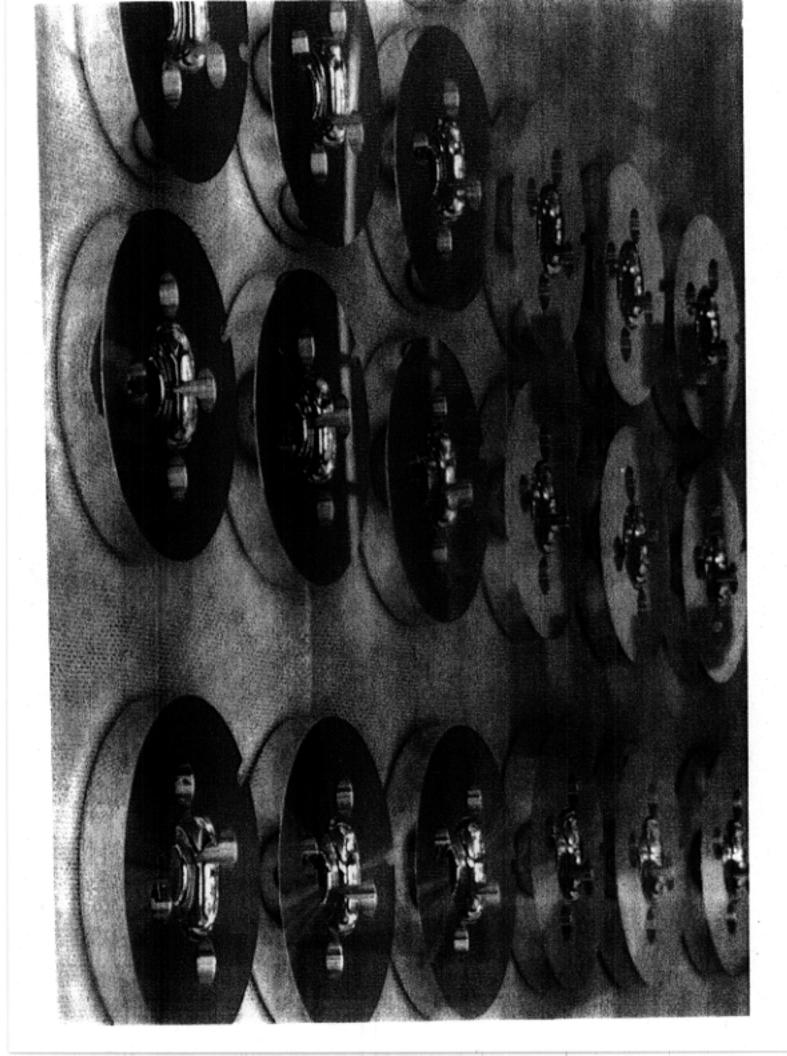
MET Inspection SLAC Department - 060 -

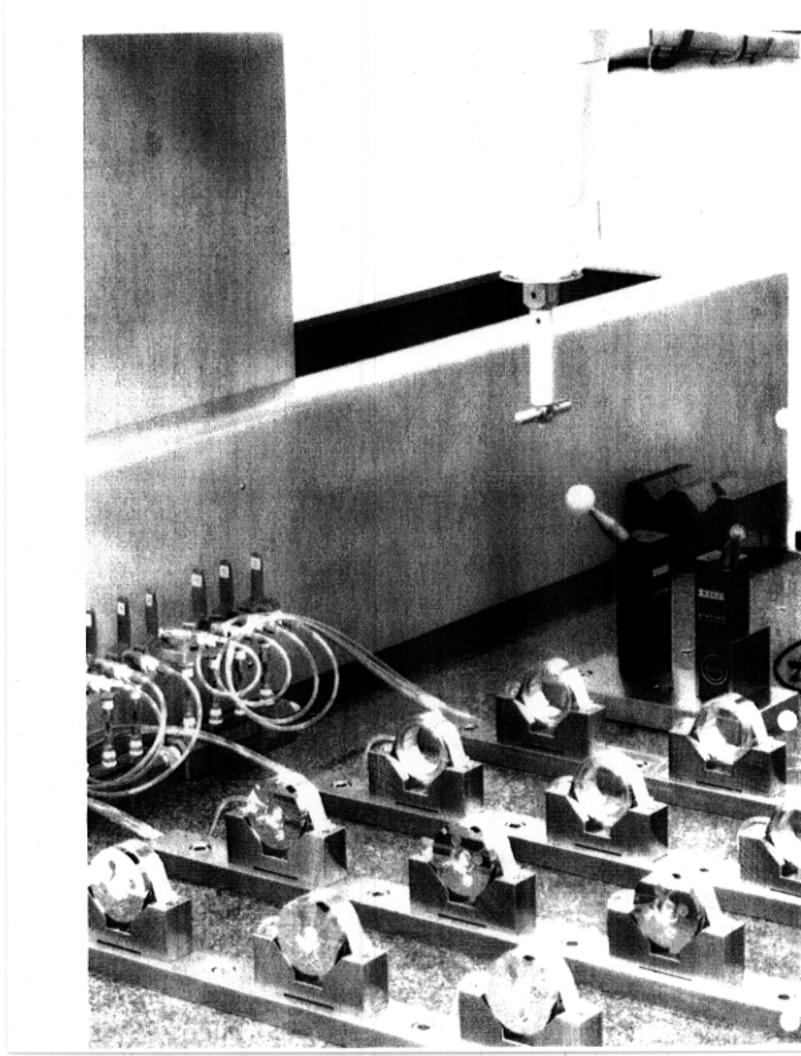
Entablished 1962

2D - CONTOUR

Date: 12-MAR-98

Time: 10: 28: 45





Other Work Worth Mentioning

ATF Linac (KEK)

1.5 GeV S-band linac with ~ 30MV/m gradient as injector for ATF dampring ring prototype.

Demonstration of beam-loading compensation with Δf scheme.

NLCTA (SLAC)

1.428 MHZ OUT OF 2855MHZ

Construct and reliably operate an engineered model of a section of the NLC high-gradient X-band linac, as of ZDR design (two-pack klystron drive, XL4, SLED-II, DDS, etc)

Testing of beam dynamics issues coupled to acceleration.

Successfully conducted beam-loading compensation with phase-amplitude modulation of SLED-II / klystron drives.

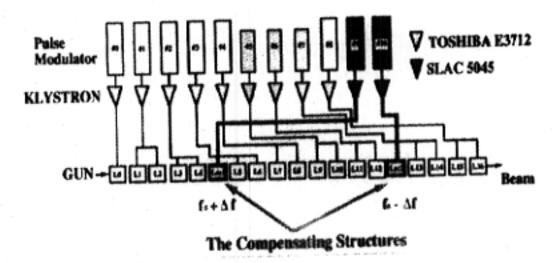
Unloaded gradient: 37 - 47 MV/m

%loading:

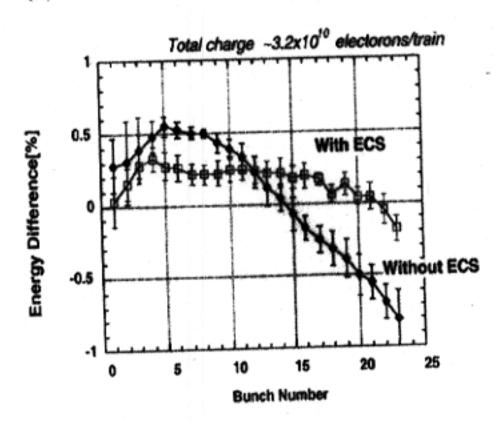
17 - 14 %

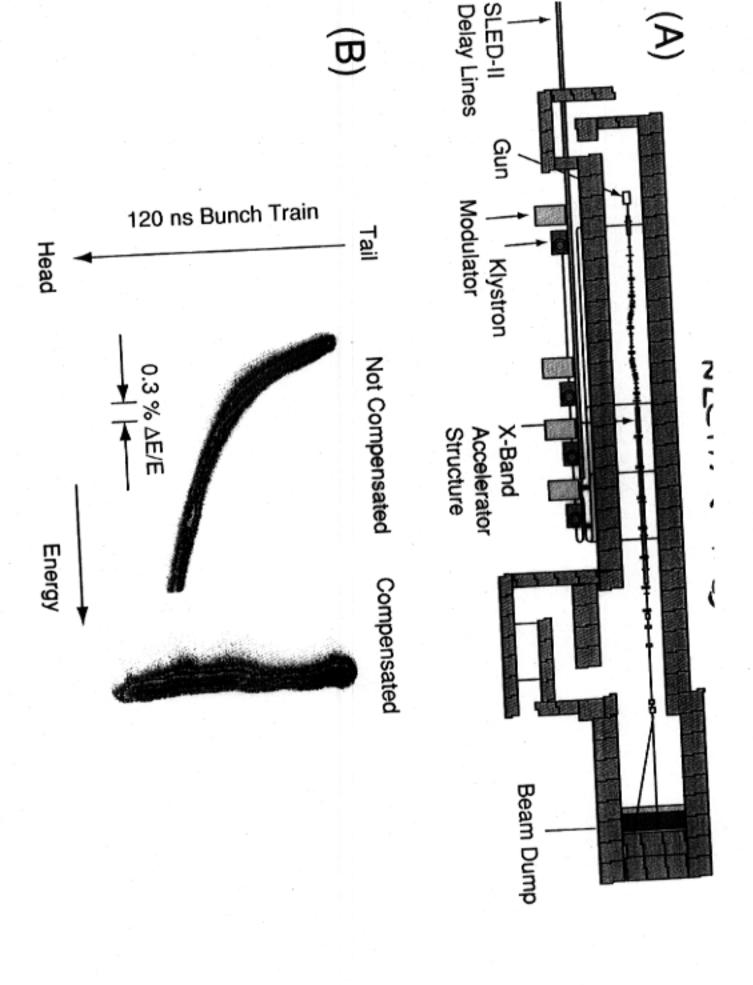
So what? They were encouraging, but We should do something similar with the latest X-band main linac scheme. also: i.e. new modulators, PPM

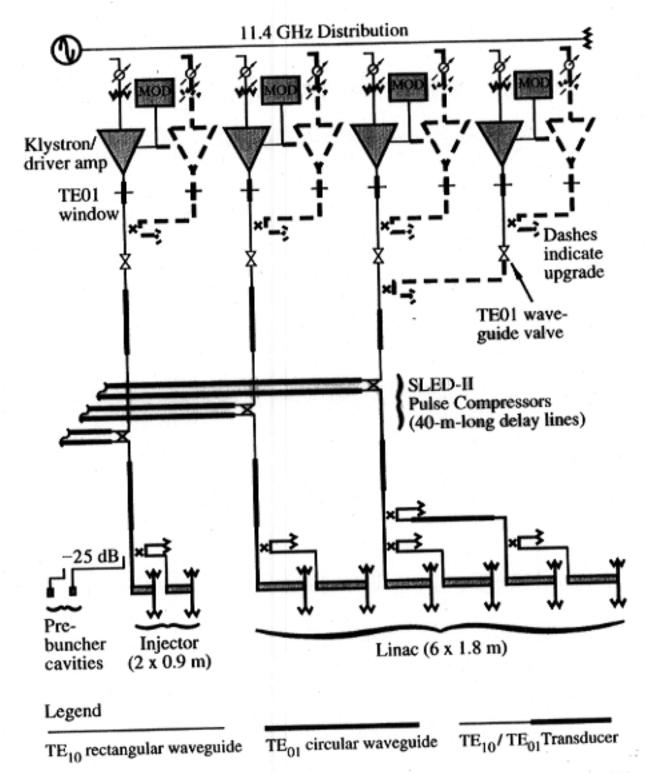
tubes, DLDS, RDDS.



(B)







Concluding Remarks

ISG framework helped a lot in accelerating the X-band R&D.

Progress Report will be submitted to KEK/SLAC directors in early yr 2000:

for their review;

for their R&D policy making for the future, in consutation with HEP communities.

Concerning industrialization issues during the R&D:

Some aspects of R&D are already done in collab with industry. Gradual increase of industry involvement is important for:

Building-up confidence in the manufacurability of components and thus, "do-ability" of LC projects.

Building-up confidence in cost estimates.

Test projects such as

8 klystrons + 12 structures + 1 DLDS "leg"

and others would reveal many "hidden" technical issues, *and* production / industrialization issues. So, we should do them.

We recognize that these pre-project R&D activities on LC will take substantial human + funding resources. We need HEP community's wide-range understanding and support.